

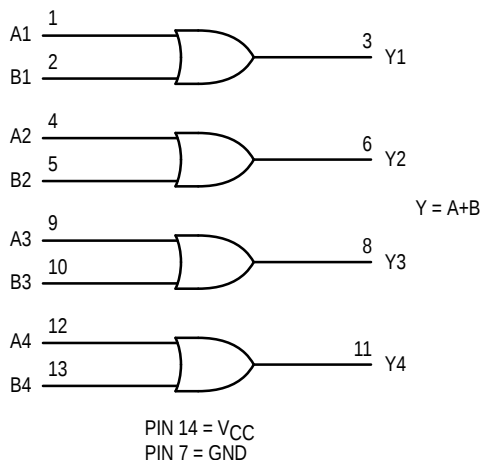
## Quad 2-Input OR Gate

### High-Performance Silicon-Gate CMOS

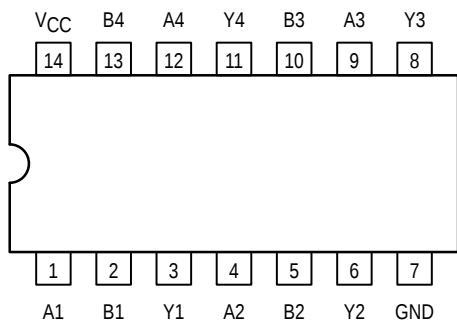
The MC54/74HC32A is identical in pinout to the LS32. The device inputs are compatible with Standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS and TTL
- Operating Voltage Range: 2 to 6V
- Low Input Current: 1 $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance With the JEDEC Standard No. 7A Requirements
- Chip Complexity: 48 FETs or 12 Equivalent Gates

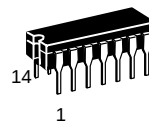
#### LOGIC DIAGRAM



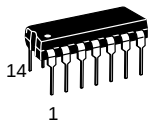
#### Pinout: 14-Lead Packages (Top View)



## MC54/74HC32A



**J SUFFIX**  
CERAMIC PACKAGE  
CASE 632-08



**N SUFFIX**  
PLASTIC PACKAGE  
CASE 646-06



**D SUFFIX**  
SOIC PACKAGE  
CASE 751A-03



**DT SUFFIX**  
TSSOP PACKAGE  
CASE 948B-03

#### ORDERING INFORMATION

|             |         |
|-------------|---------|
| MC54HCXXAJ  | Ceramic |
| MC74HCXXAN  | Plastic |
| MC74HCXXAD  | SOIC    |
| MC74HCXXADT | TSSOP   |

#### FUNCTION TABLE

| Inputs |   | Output |
|--------|---|--------|
| A      | B | Y      |
| L      | L | L      |
| L      | H | H      |
| H      | L | H      |
| H      | H | H      |



**MAXIMUM RATINGS\***

| Symbol    | Parameter                                                                                            | Value                   | Unit |
|-----------|------------------------------------------------------------------------------------------------------|-------------------------|------|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)                                                                | – 0.5 to + 7.0          | V    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)                                                                 | – 0.5 to $V_{CC} + 0.5$ | V    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)                                                                | – 0.5 to $V_{CC} + 0.5$ | V    |
| $I_{in}$  | DC Input Current, per Pin                                                                            | $\pm 20$                | mA   |
| $I_{out}$ | DC Output Current, per Pin                                                                           | $\pm 25$                | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                                                             | $\pm 50$                | mA   |
| $P_D$     | Power Dissipation in Still Air, Plastic or Ceramic DIP†<br>SOIC Package†<br>TSSOP Package†           | 750<br>500<br>450       | mW   |
| $T_{stg}$ | Storage Temperature                                                                                  | – 65 to + 150           | °C   |
| $T_L$     | Lead Temperature, 1 mm from Case for 10 Seconds<br>Plastic DIP, SOIC or TSSOP Package<br>Ceramic DIP | 260<br>300              | °C   |

\* Maximum Ratings are those values beyond which damage to the device may occur.  
Functional operation should be restricted to the Recommended Operating Conditions.

† Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C  
Ceramic DIP: – 10 mW/°C from 100° to 125°C  
SOIC Package: – 7 mW/°C from 65° to 125°C  
TSSOP Package: – 6.1 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

**RECOMMENDED OPERATING CONDITIONS**

| Symbol                             | Parameter                                            | Min                     | Max             | Unit |    |
|------------------------------------|------------------------------------------------------|-------------------------|-----------------|------|----|
| V <sub>CC</sub>                    | DC Supply Voltage (Referenced to GND)                | 2.0                     | 6.0             | V    |    |
| V <sub>in</sub> , V <sub>out</sub> | DC Input Voltage, Output Voltage (Referenced to GND) | 0                       | V <sub>CC</sub> | V    |    |
| T <sub>A</sub>                     | Operating Temperature, All Package Types             | – 55                    | + 125           | °C   |    |
| t <sub>r</sub> , t <sub>f</sub>    | Input Rise and Fall Time<br>(Figure 1)               | V <sub>CC</sub> = 2.0 V | 0               | 1000 | ns |
|                                    |                                                      | V <sub>CC</sub> = 4.5 V | 0               | 500  |    |
|                                    |                                                      | V <sub>CC</sub> = 6.0 V | 0               | 400  |    |

**DC CHARACTERISTICS** (Voltages Referenced to GND)

| Symbol          | Parameter                                      | Condition                                                                          | V <sub>CC</sub><br>V     | Guaranteed Limit             |                              |                              | Unit |
|-----------------|------------------------------------------------|------------------------------------------------------------------------------------|--------------------------|------------------------------|------------------------------|------------------------------|------|
|                 |                                                |                                                                                    |                          | -55 to 25°C                  | ≤85°C                        | ≤125°C                       |      |
| V <sub>IH</sub> | Minimum High-Level Input Voltage               | V <sub>out</sub> = 0.1V or V <sub>CC</sub> - 0.1V<br> I <sub>out</sub>   ≤ 20μA    | 2.0<br>3.0<br>4.5<br>6.0 | 1.50<br>2.10<br>3.15<br>4.20 | 1.50<br>2.10<br>3.15<br>4.20 | 1.50<br>2.10<br>3.15<br>4.20 | V    |
| V <sub>IL</sub> | Maximum Low-Level Input Voltage                | V <sub>out</sub> = 0.1V or V <sub>CC</sub> - 0.1V<br> I <sub>out</sub>   ≤ 20μA    | 2.0<br>3.0<br>4.5<br>6.0 | 0.50<br>0.90<br>1.35<br>1.80 | 0.50<br>0.90<br>1.35<br>1.80 | 0.50<br>0.90<br>1.35<br>1.80 | V    |
| V <sub>OH</sub> | Minimum High-Level Output Voltage              | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20μA | 2.0<br>4.5<br>6.0        | 1.9<br>4.4<br>5.9            | 1.9<br>4.4<br>5.9            | 1.9<br>4.4<br>5.9            | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>out</sub>   ≤ 2.4mA   | 3.0                      | 2.48                         | 2.34                         | 2.20                         |      |
|                 |                                                | I <sub>out</sub>   ≤ 4.0mA                                                         | 4.5                      | 3.98                         | 3.84                         | 3.70                         |      |
|                 |                                                | I <sub>out</sub>   ≤ 5.2mA                                                         | 6.0                      | 5.48                         | 5.34                         | 5.20                         |      |
| V <sub>OL</sub> | Maximum Low-Level Output Voltage               | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub><br> I <sub>out</sub>   ≤ 20μA | 2.0<br>4.5<br>6.0        | 0.1<br>0.1<br>0.1            | 0.1<br>0.1<br>0.1            | 0.1<br>0.1<br>0.1            | V    |
|                 |                                                | V <sub>in</sub> = V <sub>IH</sub> or V <sub>IL</sub>  I <sub>out</sub>   ≤ 2.4mA   | 3.0                      | 0.26                         | 0.33                         | 0.40                         |      |
|                 |                                                | I <sub>out</sub>   ≤ 4.0mA                                                         | 4.5                      | 0.26                         | 0.33                         | 0.40                         |      |
|                 |                                                | I <sub>out</sub>   ≤ 5.2mA                                                         | 6.0                      | 0.26                         | 0.33                         | 0.40                         |      |
| I <sub>in</sub> | Maximum Input Leakage Current                  | V <sub>in</sub> = V <sub>CC</sub> or GND                                           | 6.0                      | ±0.1                         | ±1.0                         | ±1.0                         | μA   |
| I <sub>CC</sub> | Maximum Quiescent Supply Current (per Package) | V <sub>in</sub> = V <sub>CC</sub> or GND<br>I <sub>out</sub> = 0μA                 | 6.0                      | 1.0                          | 10                           | 40                           | μA   |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

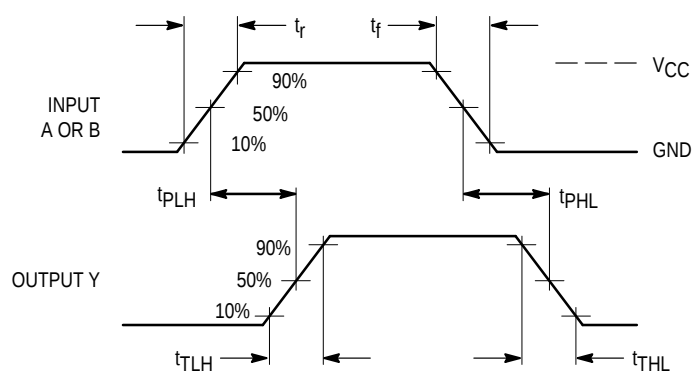
**AC CHARACTERISTICS** (C<sub>L</sub> = 50pF, Input t<sub>r</sub> = t<sub>f</sub> = 6ns)

| Symbol                                 | Parameter                                                                | V <sub>CC</sub><br>V     | Guaranteed Limit     |                      |                       | Unit |
|----------------------------------------|--------------------------------------------------------------------------|--------------------------|----------------------|----------------------|-----------------------|------|
|                                        |                                                                          |                          | -55 to 25°C          | ≤85°C                | ≤125°C                |      |
| t <sub>PLH</sub> ,<br>t <sub>PHL</sub> | Maximum Propagation Delay, Input A or B to Output Y<br>(Figures 1 and 2) | 2.0<br>3.0<br>4.5<br>6.0 | 75<br>30<br>15<br>13 | 95<br>40<br>19<br>16 | 110<br>55<br>22<br>19 | ns   |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 1 and 2)          | 2.0<br>3.0<br>4.5<br>6.0 | 75<br>27<br>15<br>13 | 95<br>32<br>19<br>16 | 110<br>36<br>22<br>19 | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                |                          | 10                   | 10                   | 10                    | pF   |

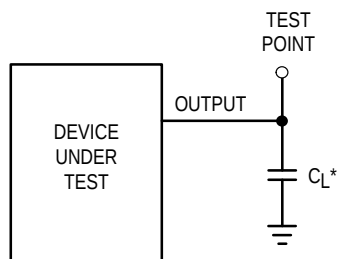
NOTE: For propagation delays with loads other than 50 pF, and information on typical parametric values, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

|                 |                                             |                                                                |    |
|-----------------|---------------------------------------------|----------------------------------------------------------------|----|
| C <sub>PD</sub> | Power Dissipation Capacitance (Per Buffer)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V, V <sub>EE</sub> = 0 V | pF |
|                 |                                             | 20                                                             |    |

\* Used to determine the no-load dynamic power consumption: P<sub>D</sub> = C<sub>PD</sub> V<sub>CC</sub><sup>2</sup>f + I<sub>CC</sub> V<sub>CC</sub>. For load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

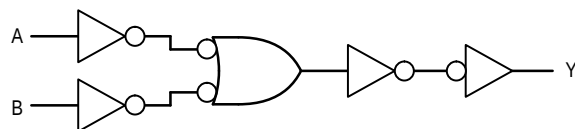


**Figure 1. Switching Waveforms**



\*Includes all probe and jig capacitance

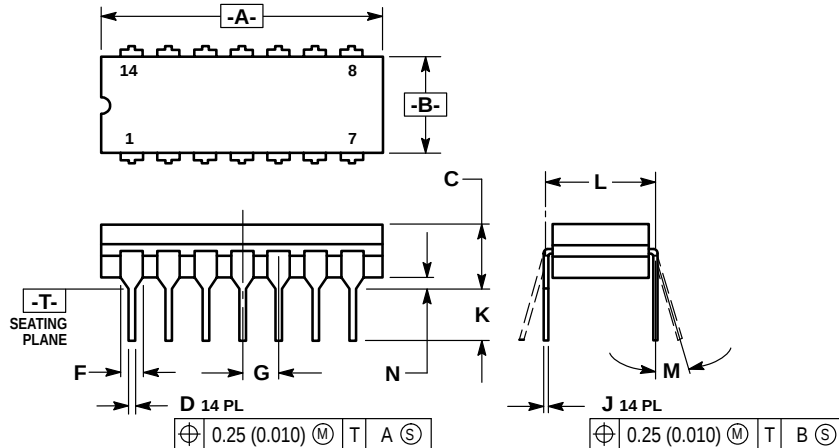
**Figure 2. Test Circuit**



**Figure 3. Expanded Logic Diagram**  
(1/4 of the Device)

## OUTLINE DIMENSIONS

**J SUFFIX**  
 CERAMIC DIP PACKAGE  
 CASE 632-08  
 ISSUE Y

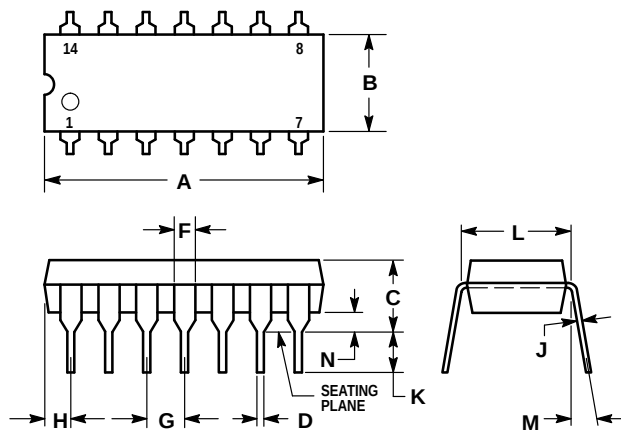


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.750     | 0.785 | 19.05       | 19.94 |
| B   | 0.245     | 0.280 | 6.23        | 7.11  |
| C   | 0.155     | 0.200 | 3.94        | 5.08  |
| D   | 0.015     | 0.020 | 0.39        | 0.50  |
| F   | 0.055     | 0.065 | 1.40        | 1.65  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.125     | 0.170 | 3.18        | 4.31  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 15°   | 0°          | 15°   |
| N   | 0.020     | 0.040 | 0.51        | 1.01  |

**N SUFFIX**  
 PLASTIC DIP PACKAGE  
 CASE 646-06  
 ISSUE L



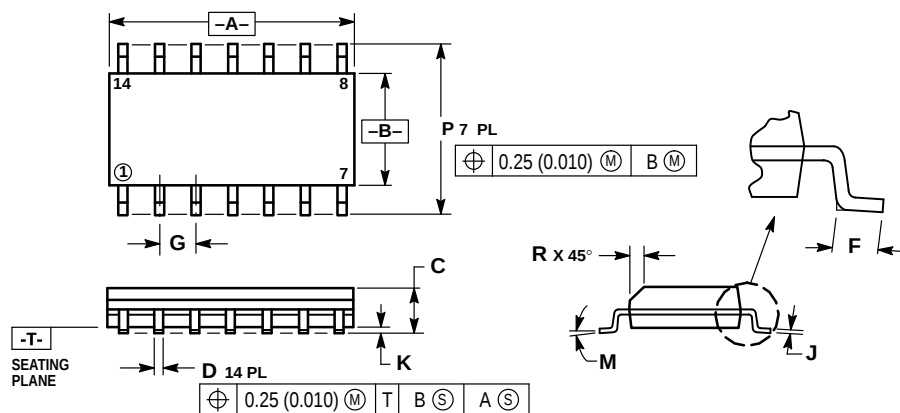
## NOTES:

1. LEADS WITHIN 0.13 (0.005) RADIUS OF TRUE POSITION AT SEATING PLANE AT MAXIMUM MATERIAL CONDITION.
2. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
3. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
4. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.715     | 0.770 | 18.16       | 19.56 |
| B   | 0.240     | 0.260 | 6.10        | 6.60  |
| C   | 0.145     | 0.185 | 3.69        | 4.69  |
| D   | 0.015     | 0.021 | 0.38        | 0.53  |
| F   | 0.040     | 0.070 | 1.02        | 1.78  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.052     | 0.095 | 1.32        | 2.41  |
| J   | 0.008     | 0.015 | 0.20        | 0.38  |
| K   | 0.115     | 0.135 | 2.92        | 3.43  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 10°   | 0°          | 10°   |
| N   | 0.015     | 0.039 | 0.39        | 1.01  |

## OUTLINE DIMENSIONS

**D SUFFIX**  
**PLASTIC SOIC PACKAGE**  
**CASE 751A-03**  
**ISSUE F**

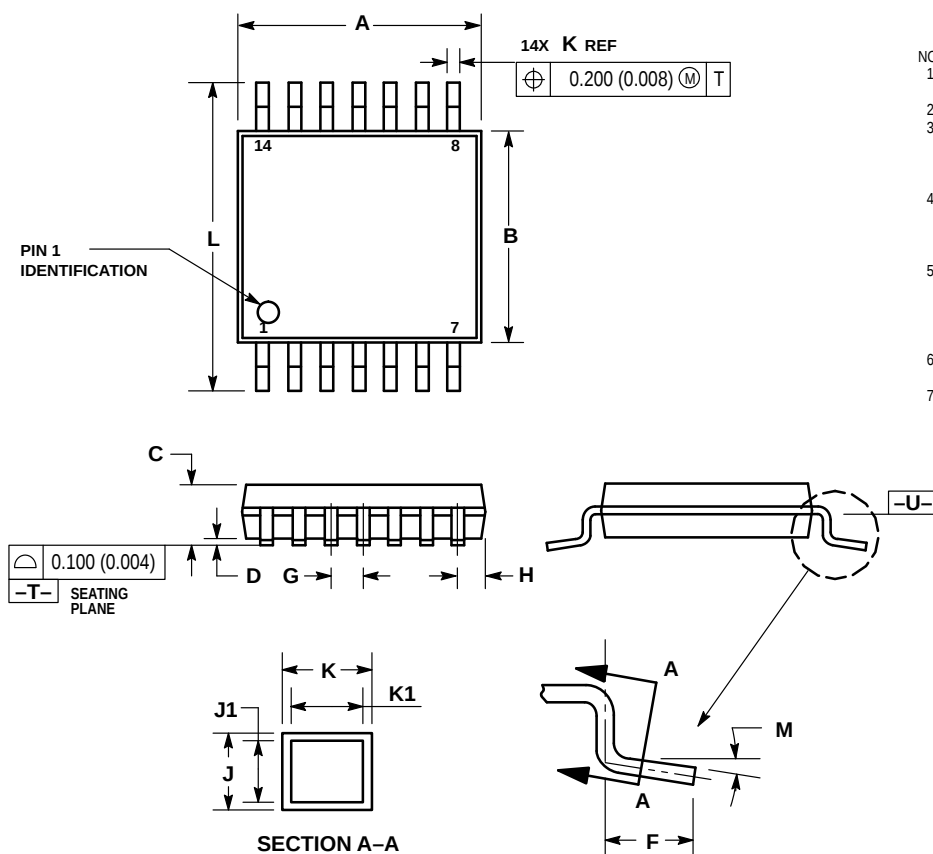


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | 8.55        | 8.75 | 0.337     | 0.344 |
| B   | 3.80        | 4.00 | 0.150     | 0.157 |
| C   | 1.35        | 1.75 | 0.054     | 0.068 |
| D   | 0.35        | 0.49 | 0.014     | 0.019 |
| F   | 0.40        | 1.25 | 0.016     | 0.049 |
| G   | 1.27 BSC    |      | 0.050 BSC |       |
| J   | 0.19        | 0.25 | 0.008     | 0.009 |
| K   | 0.10        | 0.25 | 0.004     | 0.009 |
| M   | 0°          | 7°   | 0°        | 7°    |
| P   | 5.80        | 6.20 | 0.228     | 0.244 |
| R   | 0.25        | 0.50 | 0.010     | 0.019 |

**DT SUFFIX**  
**PLASTIC TSSOP PACKAGE**  
**CASE 948B-03**  
**ISSUE A**



## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSION A DOES NOT INCLUDE MOLD FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT EXCEED 0.15 (0.006) PER SIDE.
4. DIMENSION B DOES NOT INCLUDE INTERLEAD FLASH OR PROTRUSION. INTERLEAD FLASH OR PROTRUSION SHALL NOT EXCEED 0.25 (0.010) PER SIDE.
5. DIMENSION K DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08 (0.003) TOTAL IN EXCESS OF THE K DIMENSION AT MAXIMUM MATERIAL CONDITION.
6. TERMINAL NUMBERS ARE SHOWN FOR REFERENCE ONLY.
7. DIMENSIONS A AND B ARE TO BE DETERMINED AT DATUM PLANE -U-.

| DIM | MILLIMETERS |      | INCHES    |       |
|-----|-------------|------|-----------|-------|
|     | MIN         | MAX  | MIN       | MAX   |
| A   | —           | 5.10 | —         | 0.200 |
| B   | 4.30        | 4.50 | 0.169     | 0.177 |
| C   | —           | 1.20 | —         | 0.047 |
| D   | 0.05        | 0.25 | 0.002     | 0.010 |
| F   | 0.45        | 0.55 | 0.018     | 0.022 |
| G   | 0.65 BSC    |      | 0.026 BSC |       |
| H   | 0.50        | 0.60 | 0.020     | 0.024 |
| J   | 0.09        | 0.24 | 0.004     | 0.009 |
| J1  | 0.09        | 0.18 | 0.004     | 0.007 |
| K   | 0.16        | 0.32 | 0.006     | 0.013 |
| K1  | 0.16        | 0.26 | 0.006     | 0.010 |
| L   | 6.30        | 6.50 | 0.248     | 0.256 |
| M   | 0°          | 10°  | 0°        | 10°   |

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**USA/EUROPE:** Motorola Literature Distribution;  
P.O. Box 20912; Phoenix, Arizona 85036. 1-800-441-2447

**MFAX:** RMFAX0@email.sps.mot.com -TOUCHTONE (602) 244-6609  
**INTERNET:** <http://Design-NET.com>

**JAPAN:** Nippon Motorola Ltd.; Tatsumi-SPD-JLDC, Toshikatsu Otsuki,  
6F Seibu-Butsuryu-Center, 3-14-2 Tatsumi Koto-Ku, Tokyo 135, Japan. 03-3521-8315

**HONG KONG:** Motorola Semiconductors H.K. Ltd.; 8B Tai Ping Industrial Park,  
51 Ting Kok Road, Tai Po, N.T., Hong Kong. 852-26629298



MC54/74HC32A/D

